# 74HC112; 74HCT112

Dual JK flip-flop with set and reset; negative-edge trigger
Rev. 4 — 11 January 2021 Product data sheet

### 1. General description

The 74HC112; 74HCT112 is a dual negative-edge triggered JK flip-flop. It features individual J and K inputs, clock ( $n\overline{CP}$ ) set ( $n\overline{SD}$ ) and reset ( $n\overline{RD}$ ) inputs. It also has complementary nQ and n $\overline{Q}$  outputs. The set and reset are asynchronous active LOW inputs and operate independently of the clock input. The J and K inputs control the state changes of the flip-flops as described in the mode select function table. The J and K inputs must be stable one set-up time prior to the HIGH-to-LOW clock transition for predictable operation. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

### 2. Features and benefits

- Input levels:
  - For 74HC112: CMOS level
  - For 74HCT112: TTL level
- Asynchronous set and reset
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

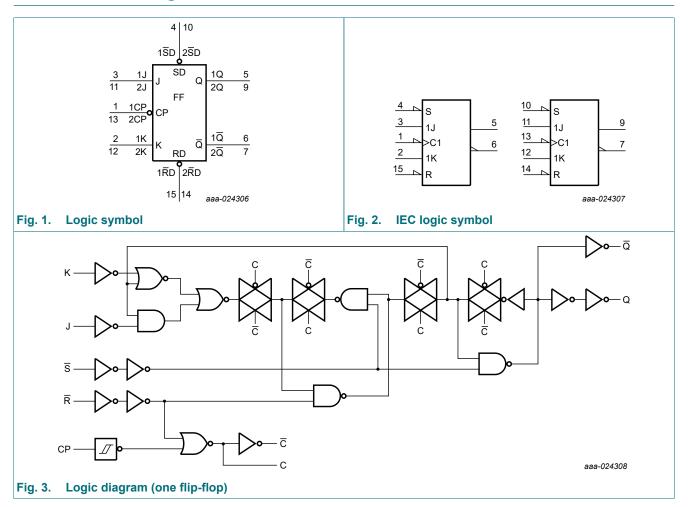
## 3. Ordering information

### **Table 1. Ordering information**

Type number	Package			
	Temperature range	Name	Description	Version
74HC112D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HCT112D				
74HC112PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1
74HCT112PW			body width 4.4 mm	

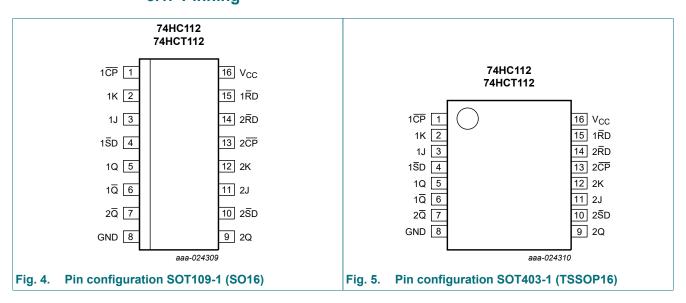


## 4. Functional diagram



## 5. Pinning information

### 5.1. Pinning



74HC\_HCT112

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## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP, 2CP	1, 13	clock input (HIGH-to-LOW; edge-triggered)
1K, 2K	2, 12	data input
1J, 2J	3, 11	data input
1SD, 2SD	4, 10	set input (active LOW)
1Q, 2Q	5, 9	true flip-flop output
1Q, 2Q	6, 7	complement flip-flop output
GND	8	ground (0 V)
1RD, 2RD	15, 14	reset input (active LOW)
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

#### **Table 3. Function selection**

If  $n\overline{S}D$  and  $n\overline{R}D$  simultaneously go from LOW-to-HIGH, the output states are unpredictable.

H = HIGH voltage level; h = HIGH voltage level one set-up time before the HIGH-to-LOW clock transition;

L = LOW voltage level; I = LOW voltage level one set-up time before the HIGH-to-LOW clock transition;

q = lowercase letters indicate the state of the referenced output one set-up time before the HIGH-to-LOW clock transition;

 $X = don't care; \downarrow = HIGH-to-LOW clock transition.$ 

Operating modes	Input		Output	Output			
	n <mark>S</mark> D	nRD	nCP	nJ	nK	nQ	nQ
Asynchronous set	L	Н	Х	Х	Х	Н	L
Asynchronous reset	Н	L	Х	Х	Х	L	Н
Undetermined	L	L	Х	Х	Х	Н	L
Toggle	Н	Н	Ţ	h	h	q	q
Load 0 (reset)	Н	Н	Ţ	I	h	L	Н
Load 1 (set)	Н	Н	Ţ	h	I	Н	L
Hold no change	Н	Н	Ţ	I	I	q	q

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V		-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I <sub>CC</sub>	supply current			-	+50	mA
I <sub>GND</sub>	ground current			-50	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation		[1]	-	500	mW

<sup>[1]</sup> For SOT109-1 (SO16) package:  $P_{tot}$  derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package:  $P_{tot}$  derates linearly with 8.5 mW/K above 91 °C.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC112		7	'4HCT11	2	Unit	
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C	;	-40 °C to	+85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC112										
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V

Symbol	Parameter	Conditions		25 °C	;	-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	1
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	٧
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	٧
		$I_{O}$ = -5.2 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	٧
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	٧
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	٧
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	4.0	-	40	-	80	μA
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT1	12					ı				
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 5.5 V	-	0.15	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μA
ΔI <sub>CC</sub>	additional supply current	per input pin; V <sub>I</sub> = V <sub>CC</sub> - 2.1 V; other inputs at V <sub>CC</sub> or GND; V <sub>CC</sub> = 4.5 V to 5.5 V								
		nSD inputs	-	50	180	-	225	-	245	μΑ
		nK inputs	-	60	216	-	270	-	294	μΑ
		nRD inputs	-	65	236	-	293	-	319	μΑ
		nJ, and nCP inputs	-	100	360	-	450	-	490	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF

## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit, see Fig. 8.

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74HC11	2		ı	I			1			
t <sub>pd</sub>	propagation	nCP to nQ; see Fig. 6 [2]								
	delay	V <sub>CC</sub> = 2.0 V	-	55	175	-	220	-	265	ns
		V <sub>CC</sub> = 4.5 V	-	20	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	17	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	16	30	-	37	-	45	ns
		nCP to nQ; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	-	55	175	-	220	-	265	ns
		V <sub>CC</sub> = 4.5 V	-	20	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	17	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	16	30	-	37	-	45	ns
		$\overline{nRD}$ to $\overline{nQ}$ , $\overline{nQ}$ ; see $\overline{\underline{Fig. 7}}$								
		V <sub>CC</sub> = 2.0 V	-	58	180	-	225	-	270	ns
		V <sub>CC</sub> = 4.5 V	-	21	36	-	45	-	54	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	18	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	17	31	-	38	-	46	ns
		nSD to nQ, nQ; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	-	50	155	-	295	-	235	ns
		V <sub>CC</sub> = 4.5 V	-	18	31	-	39	-	47	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	40	ns
t <sub>t</sub>	transition	$nQ, n\overline{Q}; see \underline{Fig. 6}$ [3]								
	time	V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	80	22	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
		nSD, nRD LOW; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	80	22	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t <sub>rec</sub>	recovery time	nRD to nCP; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	80	22	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	21	-	26	-	ns
		nSD to nCP; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	80	-19	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	-7	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	-6	-	17	-	20	-	ns
t <sub>su</sub>	set-up time	nJ and nK to n <del>CP</del> ; see <u>Fig. 6</u>								
		V <sub>CC</sub> = 2.0 V	80	19	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
t <sub>h</sub>	hold time	nJ and nK to n <del>CP</del> ; see <u>Fig. 6</u>								
		V <sub>CC</sub> = 2.0 V	0	-11	-	0	-	0	-	ns
		V <sub>CC</sub> = 4.5 V	0	-4	-	0	-	0	-	ns
		V <sub>CC</sub> = 6.0 V	0	-3	-	0	-	0	-	ns
f <sub>max</sub>	maximum	nCP; see Fig. 6								
	frequency	V <sub>CC</sub> = 2.0 V	6	20	-	4.8	-	4.0	-	MHz
		V <sub>CC</sub> = 4.5 V	30	60	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	66	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	35	71	-	28	-	24	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L = 50 \text{ pF; } f = 1 \text{ MHz;}$ [4] $V_I = \text{GND to } V_{CC}$	-	27	-			-	-	pF
74HCT1	12						1	1		
t <sub>pd</sub>	propagation	nCP to nQ; see Fig. 6 [2]								
	delay	V <sub>CC</sub> = 4.5 V	-	21	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	19	-	-	-	-	-	ns
		n <del>CP</del> to n <del>Q</del> ; see <u>Fig. 6</u>								
		V <sub>CC</sub> = 4.5 V	-	23	40	-	50	-	60	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	19	-	-	-	-	-	ns
		nRD to nQ, nQ; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	-	22	37	-	46	-	56	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	19	-	-	-	-	-	ns
		nSD to nQ, nQ; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	-	18	32	-	40	-	48	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
t <sub>t</sub>	transition	$nQ, n\overline{Q}; see \underline{Fig. 6}$ [3]								
	time	V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Fig. 6								
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		nSD, nRD LOW; see Fig. 7	40	10		22		27		no
		V <sub>CC</sub> = 4.5 V	18	10	-	23	-	27	-	ns

Symbol Parameter		Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t <sub>rec</sub>	recovery time	nRD to nCP; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	20	11	-	25	-	30	-	ns
		nSD to nCP; see Fig. 7								
		V <sub>CC</sub> = 4.5 V	20	-8	-	25	-	30	-	ns
t <sub>su</sub>	set-up time	nJ and nK to nCP; see Fig. 6								
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
t <sub>h</sub>	hold time	nJ and nK to nCP; see Fig. 6								
		V <sub>CC</sub> = 4.5 V	0	-7	-	0	-	0	-	ns
f <sub>max</sub>	maximum	nCP; see Fig. 6								
	frequency	V <sub>CC</sub> = 4.5 V	30	64	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	70	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ [4] $V_I = \text{GND to } V_{CC}$	-	30	-	-	-	-	-	pF

- [1] All typical values are measured at  $T_{amb}$  = 25 °C.
- t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.
   t<sub>t</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
- [3] t<sub>t</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
   [4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

 $f_o$  = output frequency in MHz;

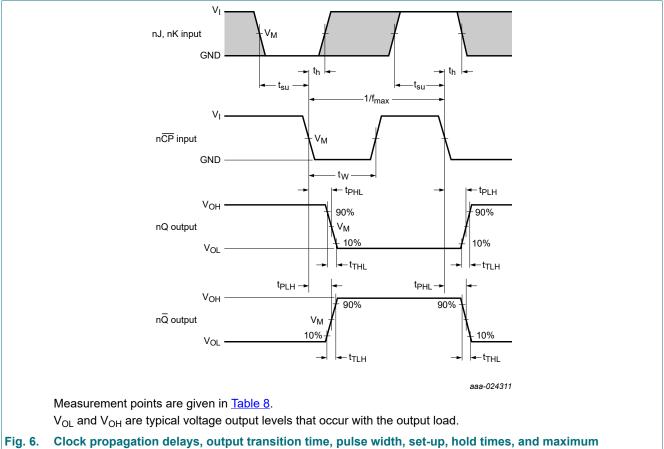
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

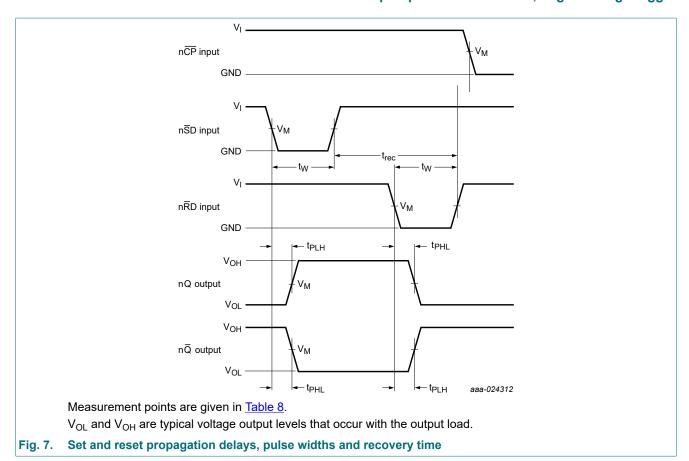
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

### 10.1. Waveforms and test circuit

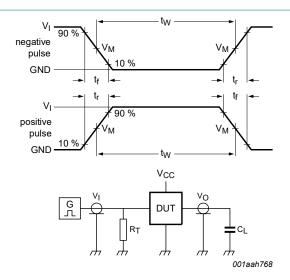


frequency



**Table 8. Measurement points** 

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC112	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT112	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 $R_{T}$  = Termination resistance should be equal to output impedance  $Z_{o}$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

#### Fig. 8. Test circuit for measuring switching times

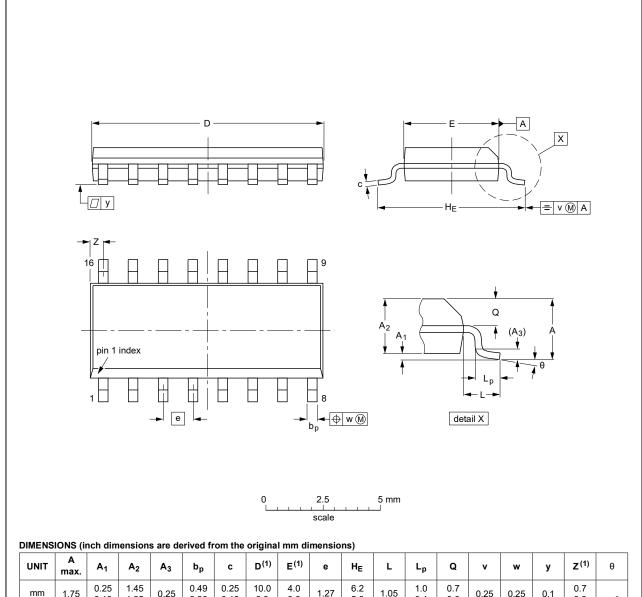
Table 9. Test data

Туре	Input L		Load	Test
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC112	V <sub>CC</sub>	6 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT112	3 V	6 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

## 11. Package outline

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



	UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
i	inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

#### Note

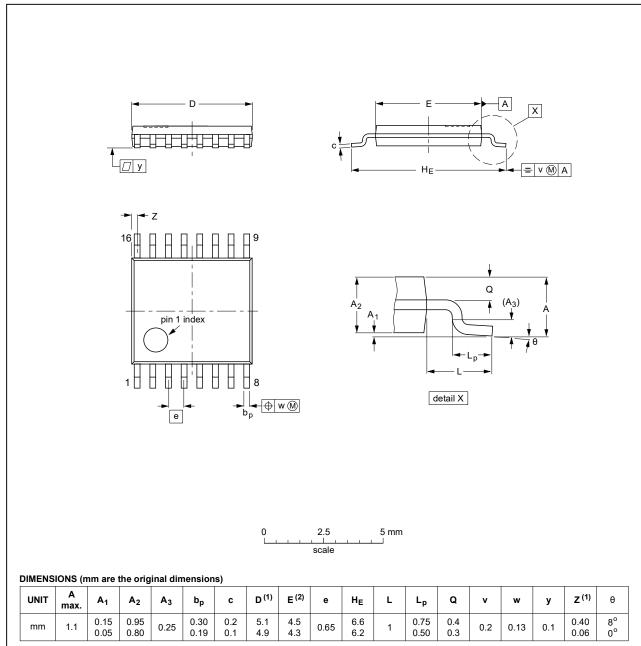
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19	

Fig. 9. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig. 10. Package outline SOT403-1 (TSSOP16)

## 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT112 v.4	20210111	Product data sheet	-	74HC_HCT112 v.3			
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type numbers 74HC112DB and 74HCT112DB (SOT338-1 / SSOP16) removed.</li> <li>Section 7: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> </ul>						
74HC_HCT112 v.3	20160809 Product data sheet - 74HC_HCT112_CNV v.						
Modifications:	The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.  Legal texts have been adapted to the new company name where appropriate.  Type numbers 74HC112N and 74HCT112N removed.						
74HC_HCT112_CNV v.2	19980610	Product specification	-	-			

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.	
Product [short] data sheet	Production	This document contains the product specification.	

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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